ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES® International and Par	PC. Bannockt	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the su	ibstances v s all lower	within the manufact level materials for	urer listed which the	item. Note: manufactur	if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and Mfg Information			
upplier Information														
ompany name*	Company unique ID				Unique ID Authority				Respon	Response Date*				
onsemi											2023-06-08			
ntact Name Title - Contact					Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative				Phone - Representative*				Email	Email - Representative*					
Product-Env-Stewards Product Enviro Compliand			ro Compliance	ance NA			Α			Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		mber Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	LC75760	LC75760UJA-AH 12CH CONTANT DRIVER		T CURRENT L	ED	2023-06-08 PHM		HM	100.67		mg	Each		
Ianufacturing Proccess Information	tion													
Terminal Plating / Grid Array Ma	Terminal Plating / Grid Array Material Terminal Base Alloy		Alloy	J-STD-020 MSI	L Rating	Peak Proc	Process Body Temperature Max Time at Peak		k Tempera	ature Num	ber of Reflow Cyc	eles		
contains Bi CU Alloy		CU Alloy		3		260		С	30	seconds 3				
omments														
FTENTION: MSL 3 Rated item require	s Bake and D	ry Pack (after	electrical test)											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.26	mg	Supplier	Silicon (Si)	7440-21-3		4.2285	mg
			Supplier	Polyimide	Proprietary Data		0.0315	mg
Die Attach	0.38	mg	Supplier	Silver (Ag)	7440-22-4		0.2698	mg
			Supplier	Epoxy resins	129915-35-1		0.1102	mg
Lead Frame	34.81	mg	Supplier	Silver (Ag)	7440-22-4		0.369	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0418	mg
			Supplier	Iron (Fe)	7439-89-6		0.8111	mg
			Supplier	Copper (Cu)	7440-50-8		33.5603	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0278	mg
Mold Compound-Black	59.22	mg		Epoxy Phenol Resin	proprietary data		7.1064	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2369	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		50.1001	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		1.7766	mg
Plating	1.71	mg	В	Bismuth (Bi)	7440-69-9		0.0103	mg
			Supplier	Tin (Sn)	7440-31-5		1.6997	mg
Wire Bond - Au	0.29	mg	Supplier	Gold (Au)	7440-57-5		0.29	mg